

#2/3-201
PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Group Art Unit: Unknown

Inventor: Chou

Serial No. To Be Assigned

Filed: Herewith

For: Microelectronic Fabrication with Upper Lying Aluminum
Fuse Layer In Copper Interconnect Semiconductor
Technology and Method For fabrication Thereof

Attorney Docket No.: 67,200-409



DISCLOSURE STATEMENT
UNDER 37 C.F.R. § 1.56

Assistant Commissioner
for Patents
Washington, D.C. 20231

Sir:

In compliance with 37 C.F.R. § 1.56, the art listed and identified on the attached Form PTO-1449 is being submitted herewith for consideration by the Examiner. A copy of each of the listed references is included herewith.

It is Applicant's opinion that the claims presently on file patentably distinguish the present invention from each of these references. The above references are being cited only in the interests of candor and without any admission that they constitute statutory prior art or contain matter which anticipates the invention or which would render the same obvious, either singly or in combination, to a person of ordinary skill in the art.

Respectfully submitted,

TUNG & ASSOCIATES

By

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